

این دیتاشیت توسط توکل الکترونیک تهیه و ارائه شده است.  
جهت مشاهده قیمت، موجودی و ثبت سفارش این قطعه به وبسایت توکل الکترونیک مراجعه فرمایید.



مشاهده قیمت و خرید  
برای خرید و مشاهده سایر محصولات کلیک کنید

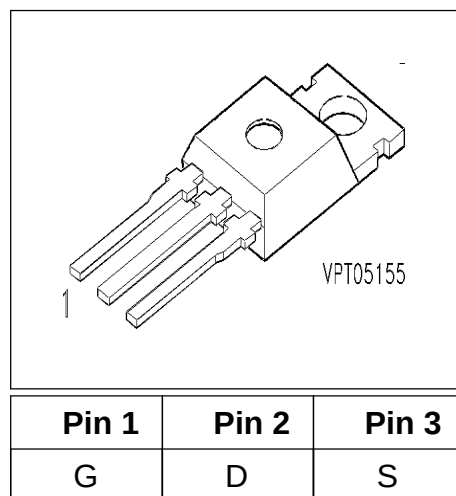


## SIEMENS

BUZ 40 B

SIPMOS<sup>®</sup> Power Transistor

- N channel
- Enhancement mode
- Avalanche-rated



| Type     | V <sub>DS</sub> | I <sub>D</sub> | R <sub>DS(on)</sub> | Package   | Ordering Code   |
|----------|-----------------|----------------|---------------------|-----------|-----------------|
| BUZ 40 B | 500 V           | 8.5 A          | 0.8 Ω               | TO-220 AB | C67078-S1305-A4 |

## Maximum Ratings

| Parameter                                                                                                                                              | Symbol      | Values        | Unit |
|--------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|---------------|------|
| Continuous drain current<br>$T_C = 35\text{ °C}$                                                                                                       | $I_D$       | 8.5           | A    |
| Pulsed drain current<br>$T_C = 25\text{ °C}$                                                                                                           | $I_{Dpuls}$ | 34            |      |
| Avalanche current, limited by $T_{jmax}$                                                                                                               | $I_{AR}$    | 10            |      |
| Avalanche energy, periodic limited by $T_{jmax}$                                                                                                       | $E_{AR}$    | 13            | mJ   |
| Avalanche energy, single pulse<br>$I_D = 10\text{ A}$ , $V_{DD} = 50\text{ V}$ , $R_{GS} = 25\text{ Ω}$<br>$L = 10.3\text{ mH}$ , $T_j = 25\text{ °C}$ | $E_{AS}$    | 570           |      |
| Gate source voltage                                                                                                                                    | $V_{GS}$    | $\pm 20$      | V    |
| Power dissipation<br>$T_C = 25\text{ °C}$                                                                                                              | $P_{tot}$   | 150           | W    |
| Operating temperature                                                                                                                                  | $T_j$       | -55 ... + 150 | °C   |
| Storage temperature                                                                                                                                    | $T_{stg}$   | -55 ... + 150 |      |
| Thermal resistance, chip case                                                                                                                          | $R_{thJC}$  | $\leq 0.83$   | K/W  |
| Thermal resistance, chip to ambient                                                                                                                    | $R_{thJA}$  | 75            |      |
| DIN humidity category, DIN 40 040                                                                                                                      |             | E             |      |
| IEC climatic category, DIN IEC 68-1                                                                                                                    |             | 55 / 150 / 56 |      |

### Electrical Characteristics, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

| Parameter                                                                                                                                                                                                        | Symbol        | Values |           |          | Unit          |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------|--------|-----------|----------|---------------|
|                                                                                                                                                                                                                  |               | min.   | typ.      | max.     |               |
| Static Characteristics                                                                                                                                                                                           |               |        |           |          |               |
| Drain- source breakdown voltage<br>$V_{GS} = 0\text{ V}$ , $I_D = 0.25\text{ mA}$ , $T_j = 25\text{ }^{\circ}\text{C}$                                                                                           | $V_{(BR)DSS}$ | 500    | -         | -        | V             |
| Gate threshold voltage<br>$V_{GS}=V_{DS}$ , $I_D = 1\text{ mA}$                                                                                                                                                  | $V_{GS(th)}$  | 2.1    | 3         | 4        |               |
| Zero gate voltage drain current<br>$V_{DS} = 500\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_j = 25\text{ }^{\circ}\text{C}$<br>$V_{DS} = 500\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_j = 125\text{ }^{\circ}\text{C}$ | $I_{DSS}$     | -<br>- | 0.1<br>10 | 1<br>100 | $\mu\text{A}$ |
| Gate-source leakage current<br>$V_{GS} = 20\text{ V}$ , $V_{DS} = 0\text{ V}$                                                                                                                                    | $I_{GSS}$     | -      | 10        | 100      | nA            |
| Drain-Source on-resistance<br>$V_{GS} = 10\text{ V}$ , $I_D = 5.5\text{ A}$                                                                                                                                      | $R_{DS(on)}$  | -      | 0.6       | 0.8      | $\Omega$      |

### Electrical Characteristics, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

| Parameter | Symbol | Values |      |      | Unit |
|-----------|--------|--------|------|------|------|
|           |        | min.   | typ. | max. |      |

#### Dynamic Characteristics

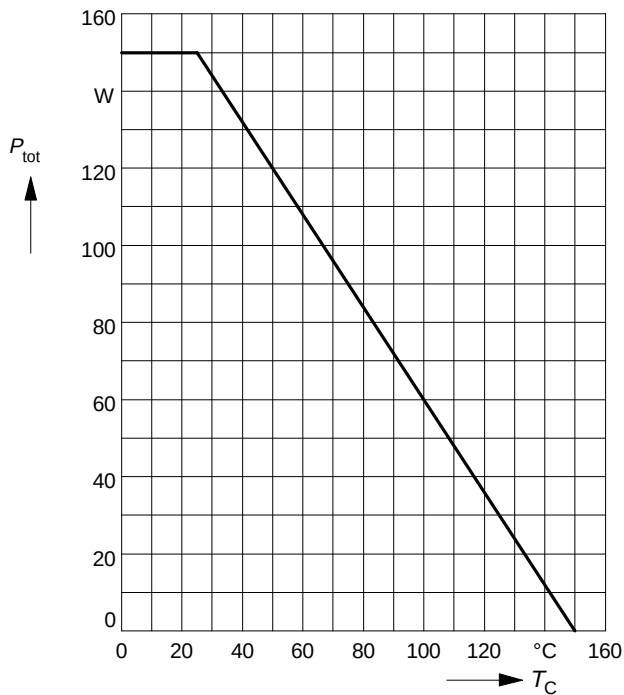
|                                                                                                                        |              |   |      |      |    |
|------------------------------------------------------------------------------------------------------------------------|--------------|---|------|------|----|
| Transconductance<br>$V_{DS} \geq 2 * I_D * R_{DS(on)max}$ , $I_D = 5.5 \text{ A}$                                      | $g_{fs}$     | 5 | 8    | -    | S  |
| Input capacitance<br>$V_{GS} = 0 \text{ V}$ , $V_{DS} = 25 \text{ V}$ , $f = 1 \text{ MHz}$                            | $C_{iss}$    | - | 1500 | 2300 | pF |
| Output capacitance<br>$V_{GS} = 0 \text{ V}$ , $V_{DS} = 25 \text{ V}$ , $f = 1 \text{ MHz}$                           | $C_{oss}$    | - | 180  | 270  |    |
| Reverse transfer capacitance<br>$V_{GS} = 0 \text{ V}$ , $V_{DS} = 25 \text{ V}$ , $f = 1 \text{ MHz}$                 | $C_{rss}$    | - | 65   | 100  |    |
| Turn-on delay time<br>$V_{DD} = 30 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 3 \text{ A}$<br>$R_{GS} = 50 \Omega$  | $t_{d(on)}$  | - | 20   | 30   | ns |
| Rise time<br>$V_{DD} = 30 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 3 \text{ A}$<br>$R_{GS} = 50 \Omega$           | $t_r$        | - | 70   | 110  |    |
| Turn-off delay time<br>$V_{DD} = 30 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 3 \text{ A}$<br>$R_{GS} = 50 \Omega$ | $t_{d(off)}$ | - | 260  | 340  |    |
| Fall time<br>$V_{DD} = 30 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 3 \text{ A}$<br>$R_{GS} = 50 \Omega$           | $t_f$        | - | 80   | 100  |    |

### Electrical Characteristics, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

| Parameter                                                                                          | Symbol   | Values |      |      | Unit          |
|----------------------------------------------------------------------------------------------------|----------|--------|------|------|---------------|
|                                                                                                    |          | min.   | typ. | max. |               |
| Reverse Diode                                                                                      |          |        |      |      |               |
| Inverse diode continuous forward current<br>$T_C = 25\text{ }^{\circ}\text{C}$                     | $I_S$    | -      | -    | 8.5  | A             |
| Inverse diode direct current,pulsed<br>$T_C = 25\text{ }^{\circ}\text{C}$                          | $I_{SM}$ | -      | -    | 34   |               |
| Inverse diode forward voltage<br>$V_{GS} = 0\text{ V}$ , $I_F = 20\text{ A}$                       | $V_{SD}$ | -      | 1.1  | 1.3  | V             |
| Reverse recovery time<br>$V_R = 100\text{ V}$ , $I_F=I_S$ , $di_F/dt = 100\text{ A}/\mu\text{s}$   | $t_{rr}$ | -      | 380  | -    | ns            |
| Reverse recovery charge<br>$V_R = 100\text{ V}$ , $I_F=I_S$ , $di_F/dt = 100\text{ A}/\mu\text{s}$ | $Q_{rr}$ | -      | 4    | -    | $\mu\text{C}$ |

### Power dissipation

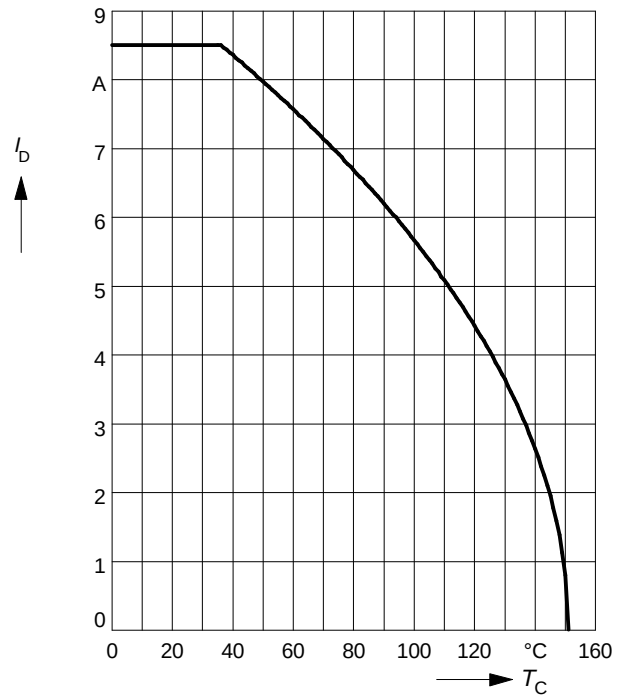
$$P_{\text{tot}} = f(T_C)$$



### Drain current

$$I_D = f(T_C)$$

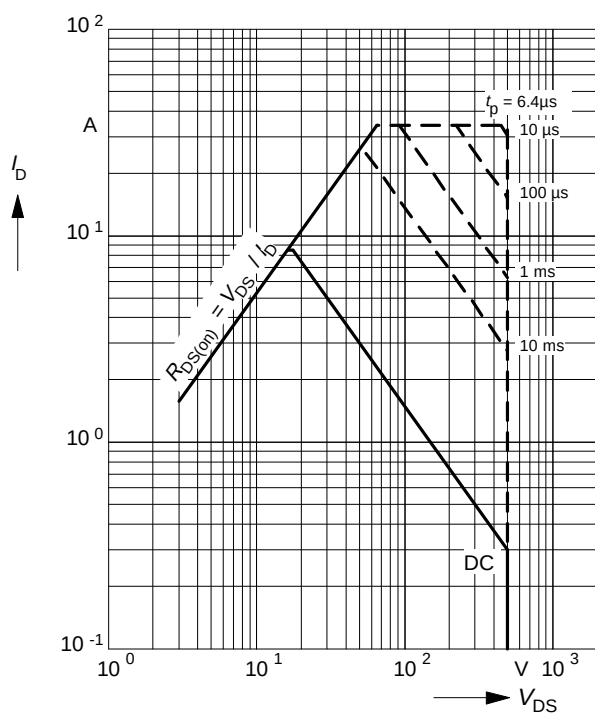
parameter:  $V_{GS} \geq 10 \text{ V}$



### Safe operating area

$$I_D = f(V_{DS})$$

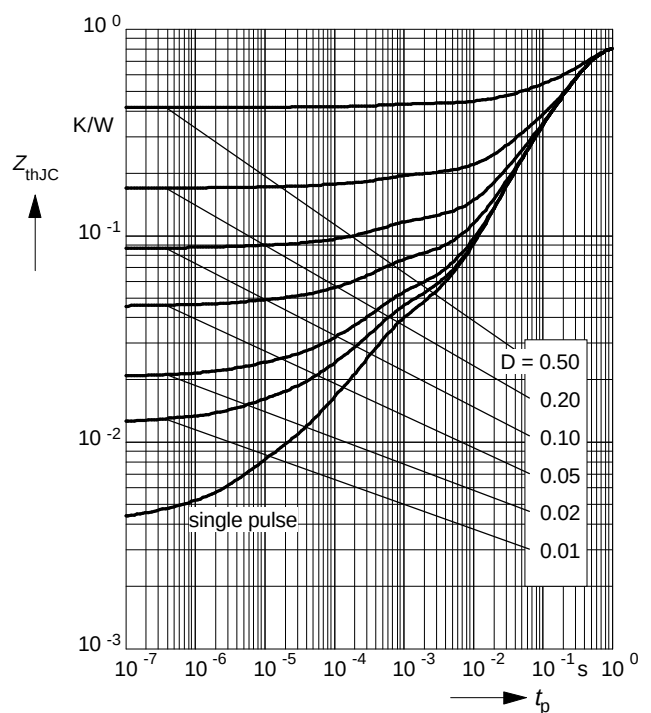
parameter:  $D = 0.01$ ,  $T_C = 25^\circ\text{C}$



### Transient thermal impedance

$$Z_{\text{th JC}} = f(t_p)$$

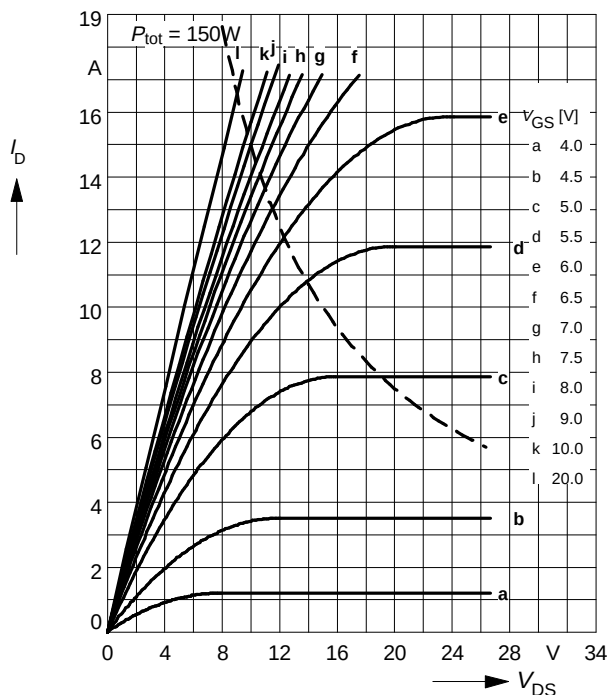
parameter:  $D = t_p / T$



## Typ. output characteristics

$$I_D = f(V_{DS})$$

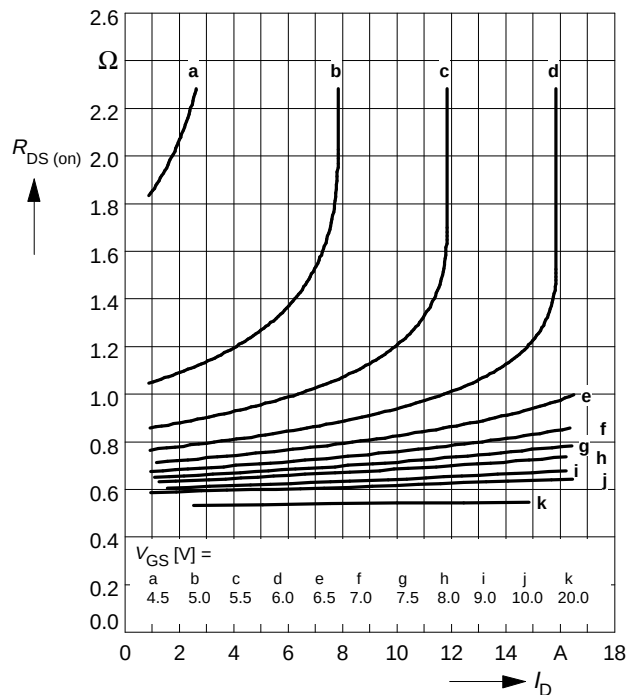
parameter:  $t_p = 80 \mu s$



## Typ. drain-source on-resistance

$$R_{DS(on)} = f(I_D)$$

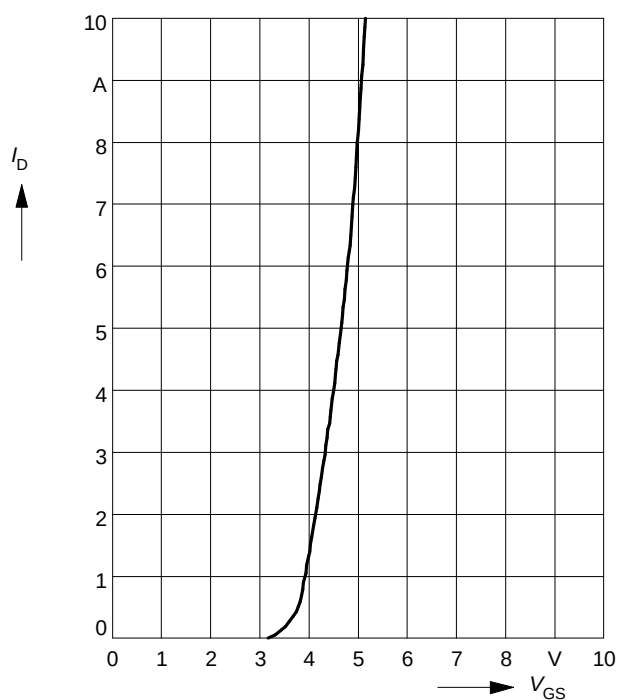
parameter:  $V_{GS}$



## Typ. transfer characteristics $I_D = f(V_{GS})$

parameter:  $t_p = 80 \mu s$

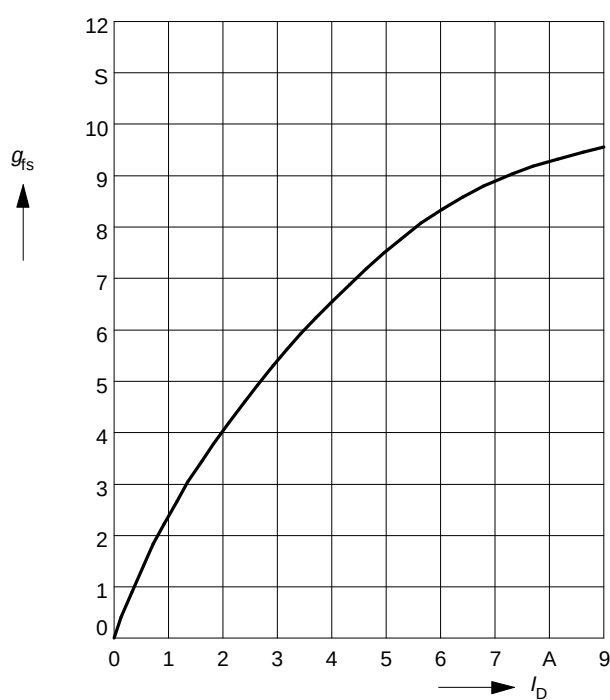
$$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$



## Typ. forward transconductance $g_{fs} = f(I_D)$

parameter:  $t_p = 80 \mu s$ ,

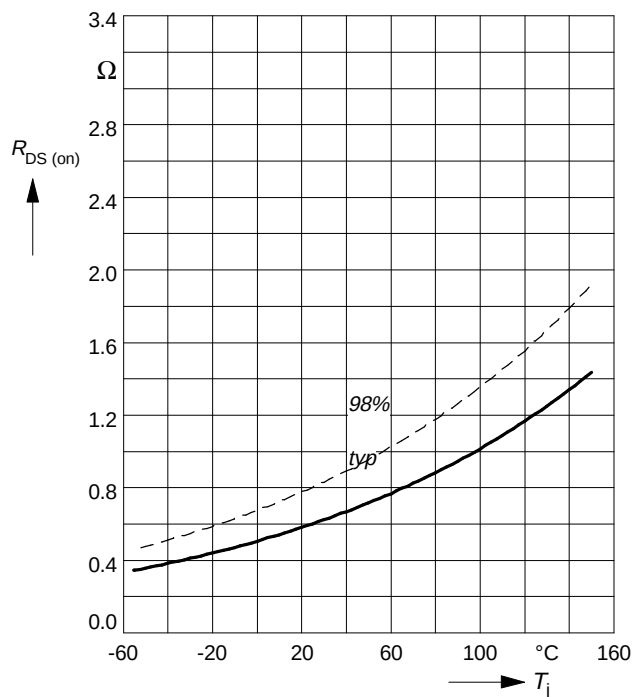
$$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$



## Drain-source on-resistance

$$R_{DS(on)} = f(T_j)$$

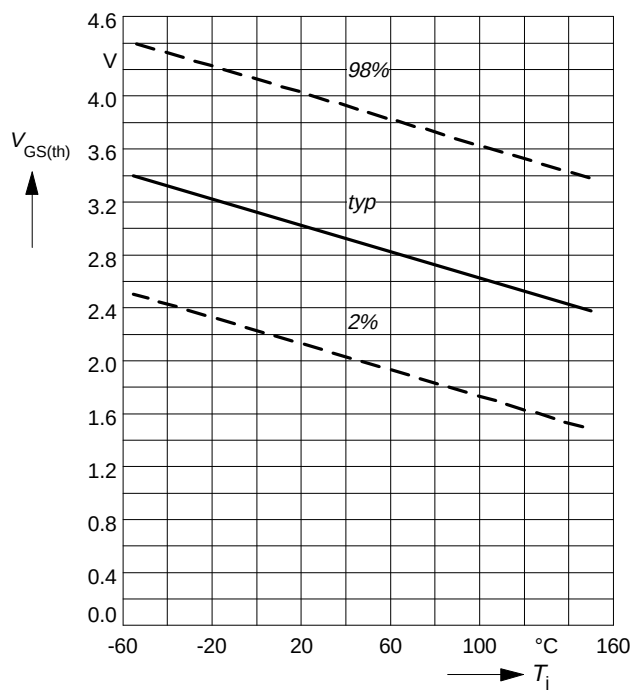
parameter:  $I_D = 5.5 \text{ A}$ ,  $V_{GS} = 10 \text{ V}$



## Gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

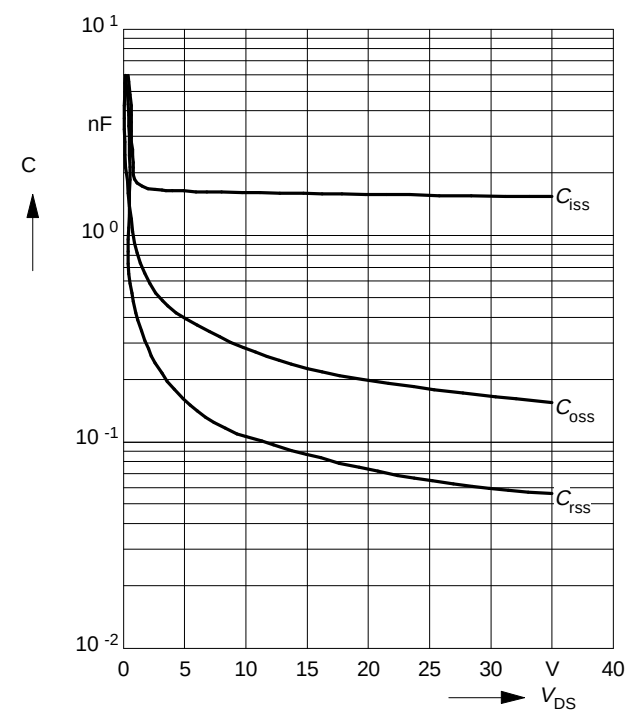
parameter:  $V_{GS} = V_{DS}$ ,  $I_D = 1 \text{ mA}$



## Typ. capacitances

$$C = f(V_{DS})$$

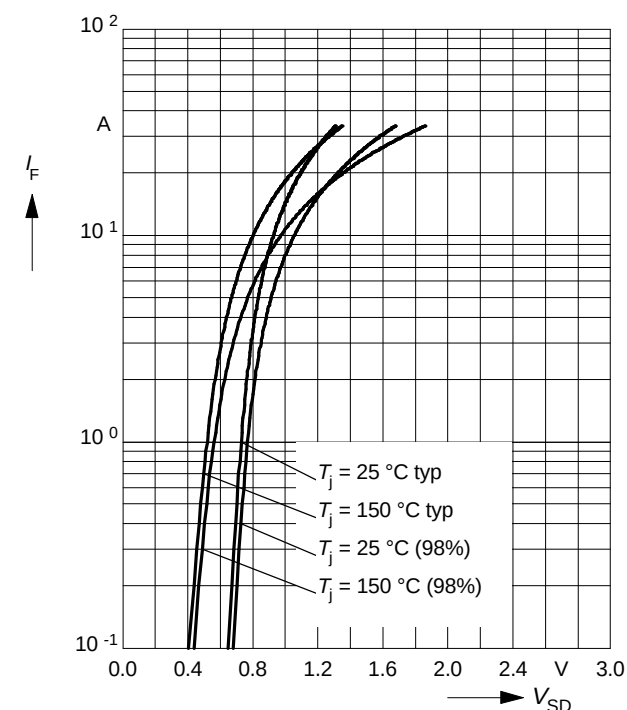
parameter:  $V_{GS} = 0 \text{ V}$ ,  $f = 1 \text{ MHz}$



## Forward characteristics of reverse diode

$$I_F = f(V_{SD})$$

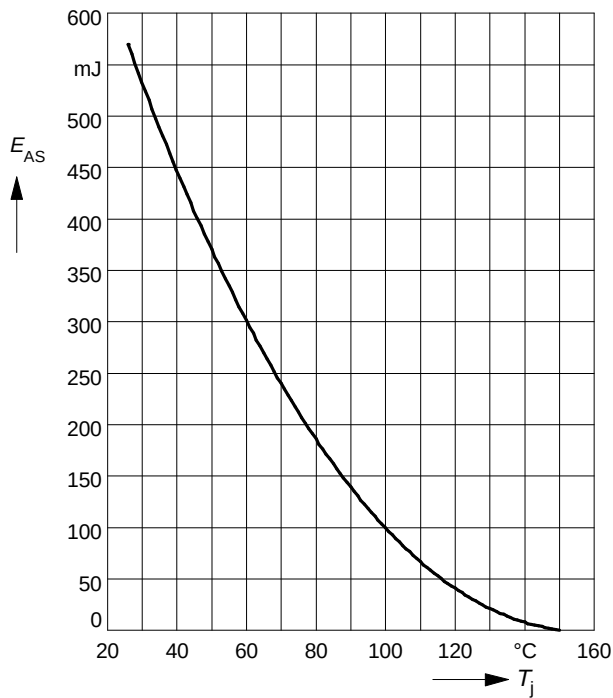
parameter:  $T_j$ ,  $t_p = 80 \mu\text{s}$



## Avalanche energy $E_{AS} = f(T_j)$

parameter:  $I_D = 10\text{ A}$ ,  $V_{DD} = 50\text{ V}$

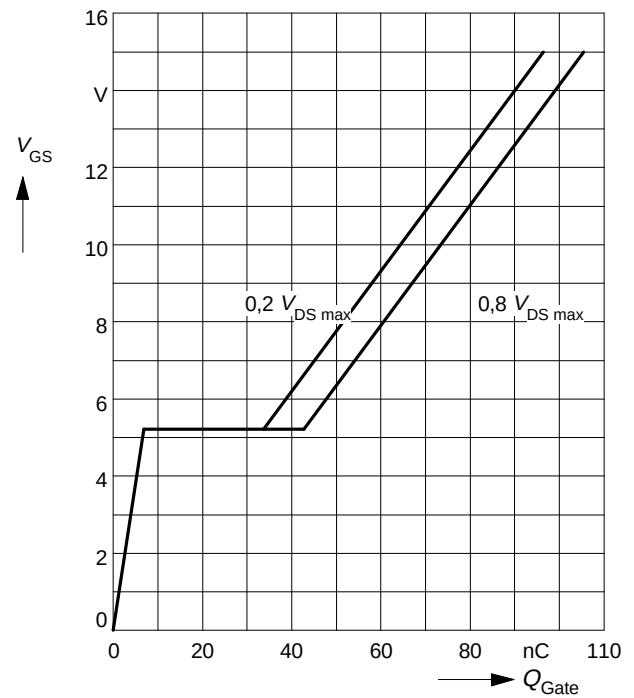
$R_{GS} = 25\ \Omega$ ,  $L = 10.3\text{ mH}$



## Typ. gate charge

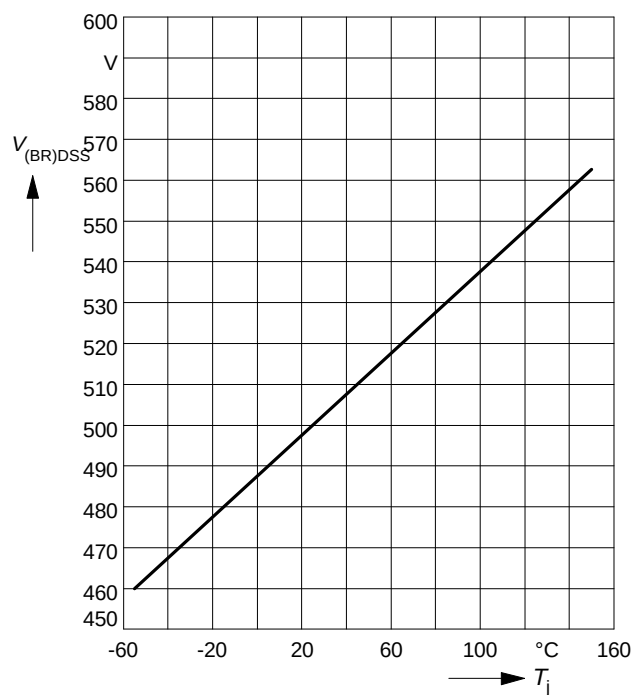
$V_{GS} = f(Q_{Gate})$

parameter:  $I_{D\text{ puls}} = 12\text{ A}$



## Drain-source breakdown voltage

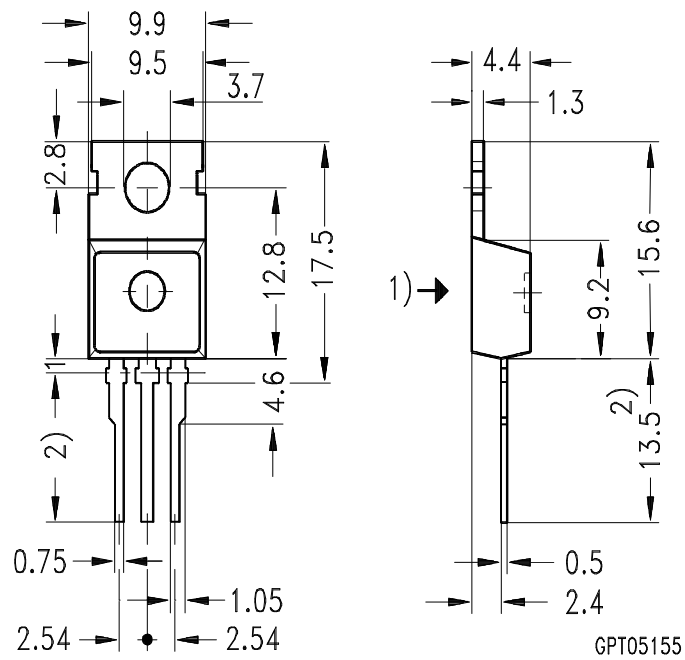
$V_{(BR)DSS} = f(T_j)$



## Package Outlines

TO-220 AB

Dimension in mm



- 1) punch direction, burr max. 0.04
- 2) dip tinning
- 3) max. 14.5 by dip tinning press burr max. 0.05